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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Modesto Oprysko et al. Examiner: Yuriy Semenenko  
Serial No: 10/620,733 Group Art Unit: 2841  
Filed: July 16, 2003 Docket: YOR920030244US1 (163-6)

For: VIA AND VIA LANDING STRUCTURES FOR SMOOTHING  
TRANSITIONS IN MULTI-LAYER SUBSTRATES

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT UNDER 37 C.F.R. §1.111

Sir:

This is a response to the Office Action mailed July 26, 2005. Please amend the  
above-identified application as follows:

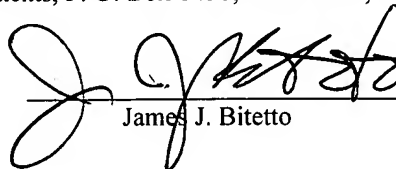
08/24/2005 EAYALEW1 00000001 500510 10620733  
01 FC:1201 600.00 DA

CERTIFICATE OF MAILING 37 C.F.R. §1.8(a)

I hereby certify that this correspondence (and any document referred to as being attached or enclosed) is being deposited with the United States Postal Service as first class mail, postage paid in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450 on

Dated:

8/19/05

  
James J. Bitetto